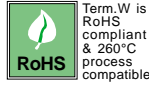


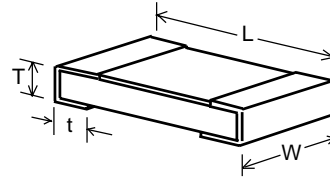
THICK FILM PRECISION CHIP RESISTORS

MILITARY GRADE

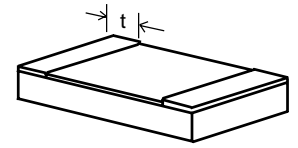
MCT SERIES



Term. W is RoHS compliant & 260°C process compatible



Wraparound Termination (standard)



Single Face Termination (Opt. S)

- Choice of termination materials: 100% tin plated nickel barrier is standard (palladium silver, gold, or tin-lead solder is available)
- Wraparound termination is standard, single sided termination is available (Option 'S')
- Wide resistance range: 0.1Ω to 100MΩ
- 100% Group A screening per MIL-R-55342 available
- Wide design flexibility for use with hybrid or smd circuitry
- Custom sizes, high surge, untrimmed chips available
- Backside metalization available

Precision performance to 0.1% 50ppm/°C!

RCD series MCT chip resistors are designed to meet applicable performance requirements of MIL-PRF-55342¹. Variety of sizes and termination materials allows wide design flexibility. Palladium silver terminations are recommended for use with conductive epoxy, gold is recommended for wire bonding, and tin plated nickel for soldering.

SPECIFICATIONS

RCD Type	Wattage @ 70°C**	Voltage Rating	Resistance Range	L* ±.008 [0.2]	W ±.008 [0.2]	t ²	T*
MCT0402	50MW	30V	10Ω - 1M	.039 [1.0]	.020 [.51]	.012±.005 [.3±.13]	.014±.006 [.35±.15]
MCT0505	100MW	50V	1Ω - 10M	.050 [1.27]	.050 [1.27]	.014±.007 [.35±.18]	.018±.006 [.45±.15]
MCT0603	100MW	40V	0.1Ω - 100M	.060 [1.53]	.030 [.76]	.012±.006 [.3±.15]	.018±.006 [.45±.15]
MCT0805	150MW	70V	0.1Ω - 100M	.075 [1.91]	.050 [1.27]	.016±.008 [.4±.2]	.018±.006 [.50±.15]
MCT1005	200MW	100V	1Ω - 20M	.100 [2.54]	.050 [1.27]	.018±.008 [.45±.2]	.020±.006 [.50±.15]
MCT1206	250MW	125V	0.1Ω - 100M	.124 [3.15]	.061 [1.55]	.020±.008 [.5±.2]	.020±.006 [.50±.15]
MCT1505	250MW	125V	1Ω - 10M	.150 [3.81]	.050 [1.27]	.020±.010 [.5±.25]	.020±.006 [.50±.15]
MCT1210	500MW	150V	0.1Ω - 100M	.124 [3.15]	.100 [2.54]	.020±.010 [.5±.25]	.020±.006 [.50±.15]
MCT2010	800MW	150V	0.1Ω - 100M	.196 [5.0]	.100 [2.54]	.020±.010 [.5±.25]	.020±.006 [.50±.15]
MCT2512	1000MW	200V	0.1Ω - 100M	.248 [6.3]	.125 [3.18]	.020±.010 [.5±.25]	.020±.006 [.50±.15]

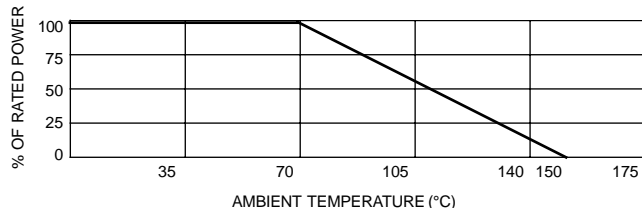
* Dimension given is for single face termination. Add .004" [1mm] for wraparound termination. ** Wattage based on mounting to ceramic substrate, derate by 25% if mounted to a glass epoxy P.C.B.

¹ Military p/n's are given for reference only and do not imply qualification or exact interchangeability. ² Dimension "t" (underside termination width) applies only to termination type W

TYPICAL PERFORMANCE CHARACTERISTICS

Characteristic	10Ω to 1MΩ range			<10Ω, >1MΩ
	±300 ppm (standard)	±100ppm (opt.)	±50ppm (opt.)	±400ppm (standard)
Temp. Coefficient	±300 ppm (standard)	±100ppm (opt.)	±50ppm (opt.)	±400ppm (standard)
Thermal Shock	0.5%	0.5%	0.5%	0.75%
Short Time Overload	0.5%	0.25%	0.25%	1%
High Temp. Exposure	0.5%	0.5%	0.5%	0.75%
Moisture Resistance	0.5%	0.5%	0.5%	1.5%
Load Life	1.0%	0.5%	0.5%	1.5%

DERATING



PART NUMBER DESIGNATION:

MCT0805 □ - **1001** - **F T 101 W**

RCD Type

Options: S = single sided termination (leave blank for wraparound termination)

Res. Value: 4 digit code if tol. is 0.1% to 1% (R100=0.1Ω, 1R00=1Ω, 10R0=10Ω, 1000=100Ω, 1001=1KΩ, 1002=10K, 1003=100K, 1004=1MΩ)
3 digit code if ≥2% (R10=0.1Ω, 1R0=1Ω, 100=10Ω, 101=100Ω, 102=1KΩ, 103=10K, 104=100K, 105=1MΩ)

Tolerance Code: B=0.1%, C=0.25%, D=0.5%, F=1%, G=2%, J=5%, K=10%, M=20%

Packaging: B=bulk, T=tape&reel, W=waffle tray

Optional TC Characteristic: 50 = 50ppm, 101 = 100ppm, 201 = 200ppm, etc. (leave blank if standard)

Termination Material: Standard = W (lead-free 100% Tin with Nickel barrier). Optional = Q (Tin-Lead solder with Ni barrier), P= untinned Palladium Silver, G=Gold